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DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

POLISHING PAD, PRODUCTION METHOD THEREOF, AND POLISHING METHOD USING THE SAME

the specification	on of which is attached hereto un	less the following is the	salead		
·	on or winer is attached hereto the	ters the tollowing is cite		:1 2 2004	
was filed o		pplication Number		April 2, 2004 as PCT	
International A	Application Number PCT/JP20 /00482		on(if applie	cable).	
I hereby state i claim(s), as an	that I have reviewed and underst nended by any amendment refert	and the contents of the a	bove-identified specification,	including the	
I acknowledge Regulations, §	the duty to disclose information 1.56.	which is material to pa	tentability as defined in Title	37, Code of Federal	
tor patent or it	foreign priority benefits under I iventor's certificate listed below ificate having a filing date before	and have also identified	below any forcign applicatio	n for patent or	
(List pract foreign				Priority Claimed	
applications. See	P2003-100376	Japan	03/04/2003	⊠ Yes □ No	
note A)	(Number)	(Country)	(Day/Month/Year Filed)	△ 163 ☐ 140	
		-			
	P2003-103477	Japan	07/04/2003	X Yes No	
	(Number)	(Country)	(Day/Month/Your Filed)		
	P2003-103624	Japan	08/04/2003	⊠ Yes □ No	
•	(Number)	(Country)	(Day/Month/Year Filed)	М 169 П 110	
		`			
				☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
(See note B) 🔲	See attached list for additional	prior foreign application	ns .		
insofar as the s in the manner information wi	the benefit under Title 35, Units subject matter of each of the clair provided by the first paragraph of hich is material to patentability a secame available between the fili- plication.	ms of this application is of Title 35, United State s defined in Title 37, Co	nor disclosed in the prior Units Code, § 112, I acknowledged of Federal Regulations,	ted States application te the duty to disclose	
I or one-II C			Stat	us	
(List pnor U.S. Applications)			Patented Pending Abandoned		
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	(Application Serial No.)	(Filing Date)			
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	(Application Serial No.)	(Filing Date)	Patented Pend	nng [] Aosndoned	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

ісе поте С)	Full name of sole or f	irst inventor (given name, family name) Nosao Suzuki	Masso SUZUKI Date SEPTEMBER 14, 2005			
		AYA-SHI, CHIBA, JAPAN	Ciuzenship Japan			
	Post Office Address	8-5-304, Kunugiyama 5-chome, Kamas				
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	O-11 C 1 : 1 :	Japan				
	Inventor's signature	entor (given name, family name)	Masato YOSHIDA			
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		Japan				
	Full name of fourth inventor (given name, family name)		Masaya NISHIYAMA			
	Inventor's signature	Masaya Nishiyama	Date SEPTEMBER 14, 2005 Citizenship			
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	Post Office Audiess	c/o HITACHI CHEMICAL CO., LTD., Yamazaki Works,				
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		Japan				
	Full name of fifth inv	entor (given name, family name)	Yasuo SHIMAMURA			
	Inventor's signature	Jusul -	Date SEPTEMBER 14, 2005			
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		_Japan				
	Full name of sixth inv Inventor's signature	entor (given name, family name)	Date			
	Residence		Citizenship			
	Post Office Address					
	TON OTHE HOMES					

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for patent or is	foreign priority benefits under T nventor's certificate listed below tificate having a filing date before	and have also identified !	below any foreign applicatio	eign application(s) n for paient or
(List prior foreig	n			Priority Claimed
applications. See		Japan	03/04/2003	⊠ Yes ☐ No
note A)	(Number)	(Country)	(Day/Month/Year Filed)	
	P2003-103477	Japan	07/04/2003	⊠ Yes □ No
	(Number)	(Country)	(Day/Month/Year Filed)	Д 100 Д 100
	P2003-103624	Japan	00/04/2002	My DNa
	(Number)	(Country)	08/04/2003 (Day/Month/Year Filed)	⊠ Yes ∐ No
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
(See note B)	See attached list for additional	• • • • • • • • • • • • • • • • • • • •	• •	
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(List prior U S			Stat	us
Applications)			Patented Pending Abandoned	
	(Application Serial No.)	(Filing Date)		
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	(Application Serial No.)	(Filing Date)	Patented Pend	ling
	•			
	(Application Serial No.)	(Filing Date)	Patented Pend	ling

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Westerman, Hartori, Daniels & Adrian, LLP 1250 Connecticur Avenue, N.W., Suite 700, Washington, D C. 20036

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ce note C)	Full name of sixth inv	entor (given name, family name)	Tomeo HIR	ANISHI	
	Inventor's signature	Tomoo Hiranishi		14, 2005	
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	Full name of seventh i	inventor (given name, family name)	Yoshinori MUROKAWA		
	Inventor's signature	Yoshinor: Mumbaya	Date SEPTEMBER	142005	
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		Јарап	20 AL, 10K/0 100 0020		
	Full name of eighth in	ventor (given name, family name)	Yasuhito IW	ATSUKT	
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	Post Office Address	c/o Shin-Kobe Electric Machinery Co.	. Ltd.		
	8-7, Nihombashi-honcho 2-chome, Chuo-ku, Tokyo 103-0023				
		Japan	uo-ma, 10My0 100 0020		
	Full name of ninth inventor (given name, family name)		Katsuji TAKAHASHI		
	Inventor's signature	Katsuii Takahashi	Date SEPTEMBER		
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	Inventor's signature	Masanobu Kouda	Date SEPTEMBER	14 2005	
	Residence HIKOI	NE-SHI, SHIGA, JAPAN	Citizenship	Јарап	
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	Post Office Address				